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FORM PTO-1595

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(exp. 4/94)



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U.S. DEPARTMENT OF
COMMERCE

Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Gerard M. Col

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

2. Name and address of receiving party(ies)

VIA Technologies, Inc.
8F, 533, Chung-Cheng Road
Hain-Tien, Taipei 231, Taiwan

Additional name(s) & address(es) attached?

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherExecution Date: 2-2-044. Application number(s) or patent number(s): 101771678If this document is being filed together with a new application, the execution date of the application is: 2-2-04

A. Patent Application No.(s)

CNTR.2094

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

James W. Huffman
Huffman Law Group, P.C.
1832 N. Cascade Ave.
Colorado Springs, CO 809076. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)..... \$40

A check in the amount of \$40 is attached hereto

8. Deposit account number: _____

9. (Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*James W. Huffman
Name of Person Signing
Signature2-4-04
DateTotal number of pages including cover sheet, attachments, and document: 3Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents and Trademarks, Box Assignments, Alexandria, VA 22313-1450

02/12/2004 LMUELLER 00000096 10771678

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PATENT
REEL: 014968 FRAME: 0371

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on even date herewith;

AND WHEREAS, VIA Technologies, Inc. together with any successors, legal representatives, or assigns thereof, with its principal office at 8F, 533, Chung-Cheng Road, Hsin-Tien, Taipei 231, Taiwan, wants to acquire the entire right, title and interest in and to the said invention(s), and to the said application and any Letters Patent that may issue thereon;


NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledge, I have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to the said VIA Technologies, Inc. its successors and assigns, the entire right, title and interest in and to the said invention and in and to the said application and all patents which may be granted thereon, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I/we hereby authorize and request the Commissioner of Patents, and any officials of foreign countries whose duty it is to issue patents on applications, to issue all patents for said invention, or patents resulting therefrom, insofar as my interest in concerned, to the said VIA Technologies, Inc. as assignee of my entire right, title and interest;

I ALSO HEREBY sell and assign to VIA Technologies, Inc. its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights;

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;


AND I HEREBY further covenant that I will communicate to said VIA Technologies, Inc or to its successors, assigns and legal representatives, any facts known to me respecting said invention, and at the expense of said testify in any VIA Technologies, Inc legal proceedings, sign all lawful papers, execute all divisional , continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said its successors VIA Technologies, Inc, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand this day and year:

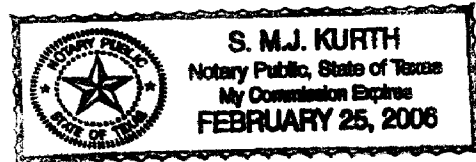
TITLE OF INVENTION	PIPELINED MICROPROCESSOR, APPARATUS, AND METHOD FOR GENERATING EARLY STATUS FLAGS		
NAME OF INVENTOR	RESIDENCE (City, State)	SIGNATURE	DATE
Gerard M. Col	11008 Conchos Tr Austin, TX 78726		2/2/04

On 02 FEB 2004, before me, Stephanie M. J. Kurth, notary public, personally appeared the above named individuals personally known to me or proved to me on the basis of satisfactory evidence, to be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

WITNESS my hand and official seal.



SIGNATURE OF NOTARY PUBLIC



PLACE NOTARY SEAL ABOVE

After recording, return Assignment to: ATTN: HUFFMAN LAW GROUP, P.C.
1832 N. Cascade Ave., Colorado Springs, CO 80907